Power MOSFET

20 V, 3.2 A, Single N-Channel, SOT-23

Features

- Leading Planar Technology for Low Gate Charge / Fast Switching
- 2.5 V Rated for Low Voltage Gate Drive
- SOT-23 Surface Mount for Small Footprint
- NVR Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

Applications

- Load/Power Switch for Portables
- Load/Power Switch for Computing
- DC-DC Conversion

MAXIMUM RATINGS (T, = 25°C unless otherwise stated)

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V _{DSS}	20	V
Gate-to-Source Voltage			V _{GS}	±12	V
Continuous Drain	Steady T _A = 25°C		I _D	3.2	Α
Current (Note 1) State T _A :		T _A = 85°C		2.4	Α
Steady State Power Dissipation (Note 1)	Stea	dy State	P _D	1.25	W
Pulsed Drain Current	t _p =	: 10 μs	I _{DM}	10.0	Α
Operating Junction and Storage Temperature			T _J , T _{stg}	–55 to 150	°C
Continuous Source Current (Body Diode)			Is	1.6	Α
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			TL	260	°C

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Max	Unit
Junction-to-Ambient (Note 1)	$R_{\theta JA}$	100	°C/W
Junction-to-Ambient (Note 2)	$R_{\theta JA}$	300	

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

- 1. Surface-mounted on FR4 board using 1 in sq pad size (Cu area = 1.127 in sq [1 oz] including traces).
- 2. Surface-mounted on FR4 board using the minimum recommended pad size.

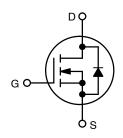


ON Semiconductor®

http://onsemi.com

V _{(BR)DSS}	R _{DS(on)} Typ	I _D Max (Note 1)
20 V	70 mΩ @ 4.5 V	3.6 A
	88 mΩ @ 2.5 V	3.1 A

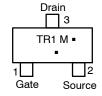
N-Channel



MARKING DIAGRAM & PIN ASSIGNMENT



SOT-23 CASE 318 STYLE 21



TR1 = Device Code

M = Date Code*

= Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping†		
NTR4501NT1G	SOT-23 (Pb-Free)	3000 / Tape & Reel		
NVR4501NT1G	SOT-23 (Pb-Free)	3000 / Tape & Reel		

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

^{*}Date Code orientation and/or overbar may vary depending upon manufacturing location.

Electrical Characteristics ($T_J = 25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Тур	Max	Units
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage (Note 3)	V _{(BR)DSS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		20	24.5		V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J				22		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V	T _J = 25°C			1.5	μΑ
		V _{DS} = 16 V	T _J = 85°C			10	μΑ
Gate-to-Source Leakage Current	I _{GSS}	$V_{DS} = 0 V, V_{C}$	_{GS} = ±12 V			±100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage (Note 3)	V _{GS(TH)}	V _{GS} = V _{DS} , I _E	_O = 250 μA	0.65		1.2	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J				-2.3		mV/°C
Drain-to-Source On Resistance	V _{GS} = 4.5 V, I _D = 3.6 A			70	80	<u> </u>	
	R _{DS(on)}	V _{GS} = 2.5 V, I _D = 3.1 A			88	105	mΩ
Forward Transconductance	9FS	V _{DS} = 5.0 V, I _D = 3.6 A			9		S
CHARGES AND CAPACITANCES						•	
Input Capacitance	C _{iss}	$V_{GS} = 0 \text{ V, f} = 1.0 \text{ MHz,}$ $V_{DS} = 10 \text{ V}$			200		pF
Output Capacitance	C _{oss}				80		
Reverse Transfer Capacitance	C _{rss}				50		
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 4.5 V, V _{DS} = 10 V, I _D = 3.6 A			2.4	6.0	nC
Gate-to-Source Gate Charge	Q _{GS}				0.5		
Gate-to-Drain Charge	Q_{GD}	. _D – 3.			0.6		1
SWITCHING CHARACTERISTICS (Note 4)						•	
Turn-On Delay Time	t _{d(on)}				6.5	13	
Rise Time	t _r	V _{GS} = 4.5 V, V	/ _{DS} = 10 V,		12	24	1
Turn-Off Delay Time	t _{d(off)}	$I_D = 3.6 \text{ A}, R_G = 6.0 \Omega$			12	24	ns -
Fall Time	t _f				3	6	
SOURCE-DRAIN DIODE CHARACTERISTICS	3		•			•	•
Forward Diode Voltage	V_{SD}	V _{GS} = 0 V, I _{SD} = 1.6 A			0.8	1.2	V
Reverse Recovery Time	t _{RR}	$V_{GS} = 0 \text{ V},$ $d_{IS}/d_t = 100 \text{ A}/\mu\text{s},$ $I_S = 1.6 \text{ A}$			7.1		
Charge Time	t _a				5		ns
Discharge Time	t _b				1.9		1
Reverse Recovery Charge	Q _{RR}				3.0		nC

Pulse Test: Pulse width ≤ 300 μs, duty cycle ≤ 2%.
 Switching characteristics are independent of operating junction temperatures.

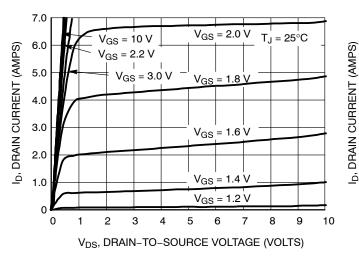
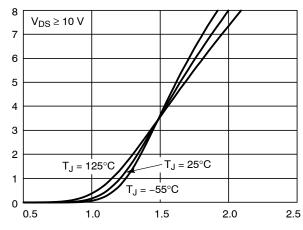


Figure 1. On-Region Characteristics



V_{GS}, GATE-TO-SOURCE VOLTAGE (VOLTS)

Figure 2. Transfer Characteristics

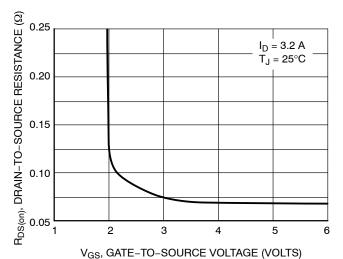


Figure 3. On–Resistance versus Gate–to–Source Voltage

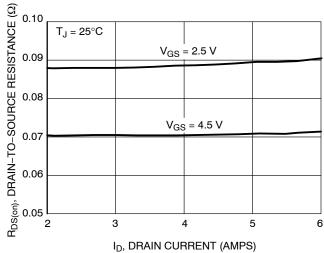


Figure 4. On-Resistance versus Drain Current and Gate Voltage

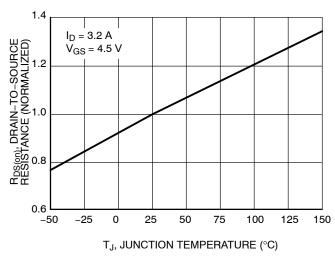
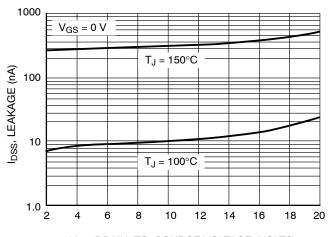


Figure 5. On–Resistance Variation with Temperature



V_{DS}, DRAIN-TO-SOURCE VOLTAGE (VOLTS)

Figure 6. Drain-to-Source Leakage
Current versus Voltage

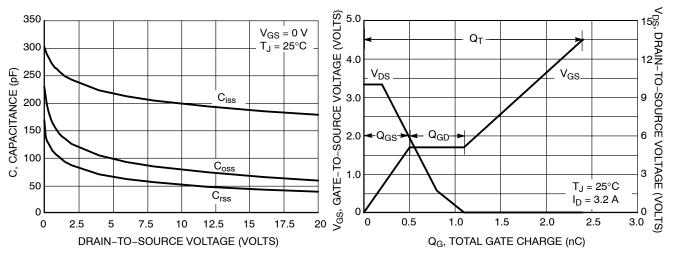


Figure 7. Capacitance Variation

Figure 8. Gate-to-Source and Drain-to-Source Voltage versus Total Charge

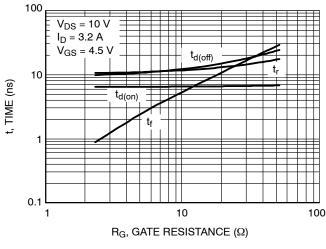


Figure 9. Resistive Switching Time Variation versus Gate Resistance

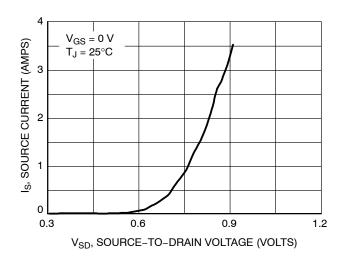


Figure 10. Diode Forward Voltage versus
Current

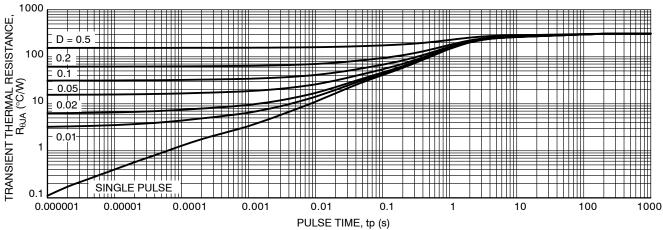
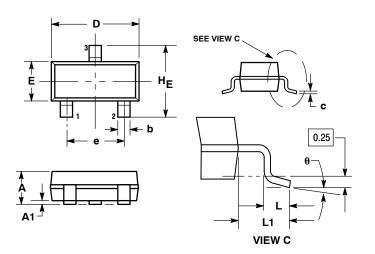


Figure 11. Thermal Response

PACKAGE DIMENSIONS

SOT-23 (TO-236) CASE 318-08 ISSUE AP



NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M. 1982.
- 2. CONTROLLING DIMENSION: INCH.
- THICKNESS IN THICKNESS INCLUDES LEAD FINISH
 THICKNESS ININIMUM LEAD THICKNESS IS THE MINIMUM
 THICKNESS OF BASE MATERIAL.
- DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

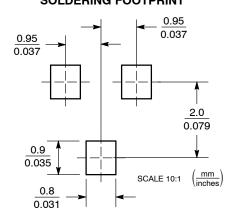
	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.89	1.00	1.11	0.035	0.040	0.044
A1	0.01	0.06	0.10	0.001	0.002	0.004
b	0.37	0.44	0.50	0.015	0.018	0.020
С	0.09	0.13	0.18	0.003	0.005	0.007
D	2.80	2.90	3.04	0.110	0.114	0.120
E	1.20	1.30	1.40	0.047	0.051	0.055
е	1.78	1.90	2.04	0.070	0.075	0.081
L	0.10	0.20	0.30	0.004	0.008	0.012
L1	0.35	0.54	0.69	0.014	0.021	0.029
HE	2.10	2.40	2.64	0.083	0.094	0.104
θ	0°		10°	0°		10°

STYLE 21:

PIN 1. GATE

SOURCE
 DRAIN

SOLDERING FOOTPRINT



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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